

# Manual iAQ-core test samples

Indoor Air Quality sensor module for consumer applications

- I<sup>2</sup>C interface
- SMD type package
- Reflow capable



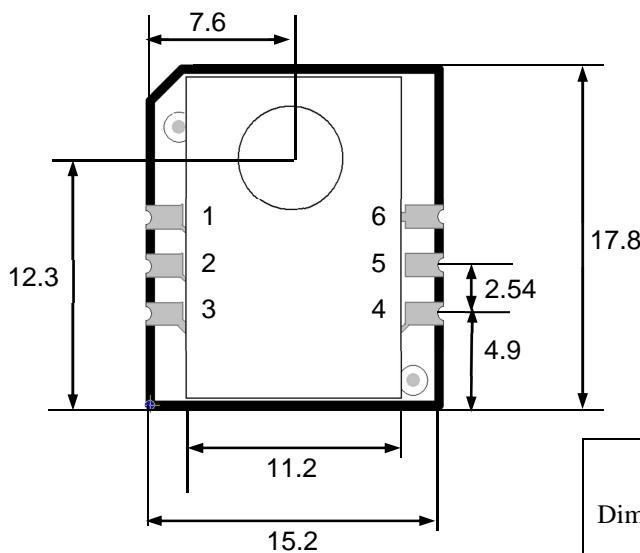
## Product summary

The iAQ-core is used to measure VOC levels and provide CO<sub>2</sub> equivalent predictions. The data is available via I<sup>2</sup>C bus.

The sensor itself is protected by a plastic cap and a filter membrane. The sensor module can be soldered directly to a host circuit board with selective or reflow soldering via the edge connectors. The sensor is protected by a membrane, which should not be removed.

**!** Note: Please read the I<sup>2</sup>C addressing instructions carefully. An undefined use of the I<sup>2</sup>C interface could harm the iAQ-core module and cause a loss of functionality.

## Dimensions



**Figure 1:** iAQ-core sensor  
(dimensions in mm, Top View)

Pin	Name	Comment
1	NC	Not connected
2	SCL	I <sup>2</sup> C serial clock
3	GND	Ground
4	SDA	I <sup>2</sup> C serial data
5	NC	Not connected
6	VCC	+3.3V

Dimensions (approximate values)	PCB 15.24 x 17.78 x 1.7 mm CAP 11.2 x 17.78 x 2.6 mm TOTAL HEIGHT 4.3 mm
Sensor position (approximate values)	7.6 x 12.3 mm Radius 3.5 mm
Weight	Approximately 1g
IP-Class	00 (at proper installation)
Connector	Card edge (cut via)

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## 1 Electrical specifications

### 1.1 Power supply

Voltage	$3.3V \pm 0.1V$ , max. 20mV ripple
Power consumption	max 92.4mW @ 3.3VDC (28mA)

**Note:** decoupling capacitor included in design.

### 1.2 Communication

Output signal options	I <sup>2</sup> C
First functional reading after start up	15 minutes (can be reduced in specific applications)

→ For more communication details see chapter 4

## 2 Environmental specifications

Temperature range operation	0 to 50°C
Temperature range storage	-25 to 50°C
Humidity range	5 to 95 %r.h., non-condensing

## 3 Sensor Features

Sensing technology	MEMS metal oxide sensor
Sensing range	I <sup>2</sup> C: 450 – 2000 ppm CO <sub>2</sub> equivalents (relative)
Module	Automatic baseline correction

## 4 I<sup>2</sup>C Interface

### 4.1 Interface description

#### 4.1.1 Physical interface

The physical interface is two-wire open drain SCL (clock) and SDA (data).

Pull-up resistors	External pull-up resistor required
Clock speed	100kHz
Clock stretching	Bus master clock stretching support is required

#### 4.1.2 Clock stretching

Clock stretching pauses a transaction by holding the clock line low. The transaction cannot continue until the line is released to high again. Although the module could send the bytes of data at a fast rate, it could happen that the module is busy at the request time. It can then hold the clock line low after reception and acknowledgement of a byte to force the master into a wait state until the iAQ-core module is ready for the next byte transfer in a type of handshake procedure. (See official I<sup>2</sup>C specification and user manual UM10204, [http://www.nxp.com/documents/user\\_manual/UM10204.pdf](http://www.nxp.com/documents/user_manual/UM10204.pdf))

#### 4.1.3 Address

Standard 7 bit I<sup>2</sup>C address for iAQ-core is **decimal 90** or **hexadecimal 0x5A**. The addressing byte includes the read/write bit at the lowest significant bit. The communication with the iAQ-core starts with **0xB5** for reading data.

**Please note:** avoid addressing the iAQ-core with write bit. This could cause a loss of communication relevant information on modules side and the iAQ-core is no longer contactable.

Bit	Address							R/ W
	7	6	5	4	3	2	1	
data	1	0	1	1	0	1	0	1

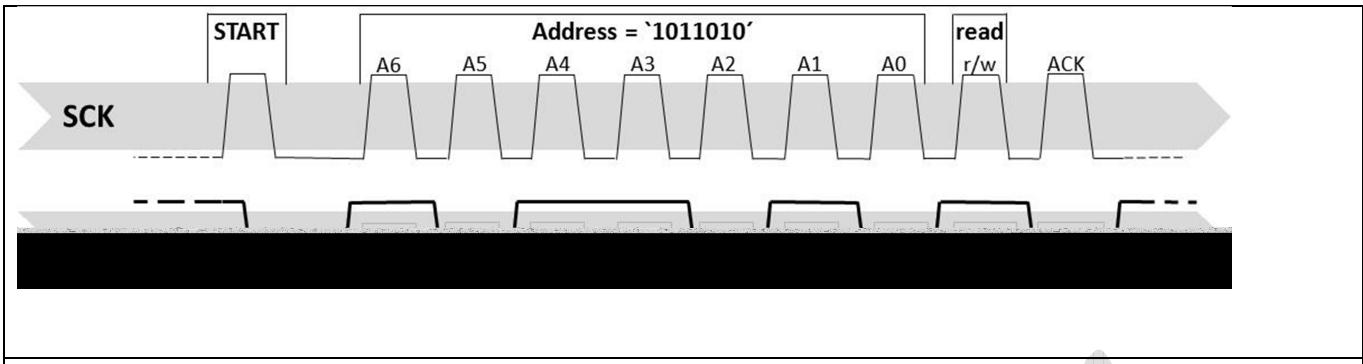
**Table 1:** Addressing byte for the iAQ-core

## 4.2 Interface protocol

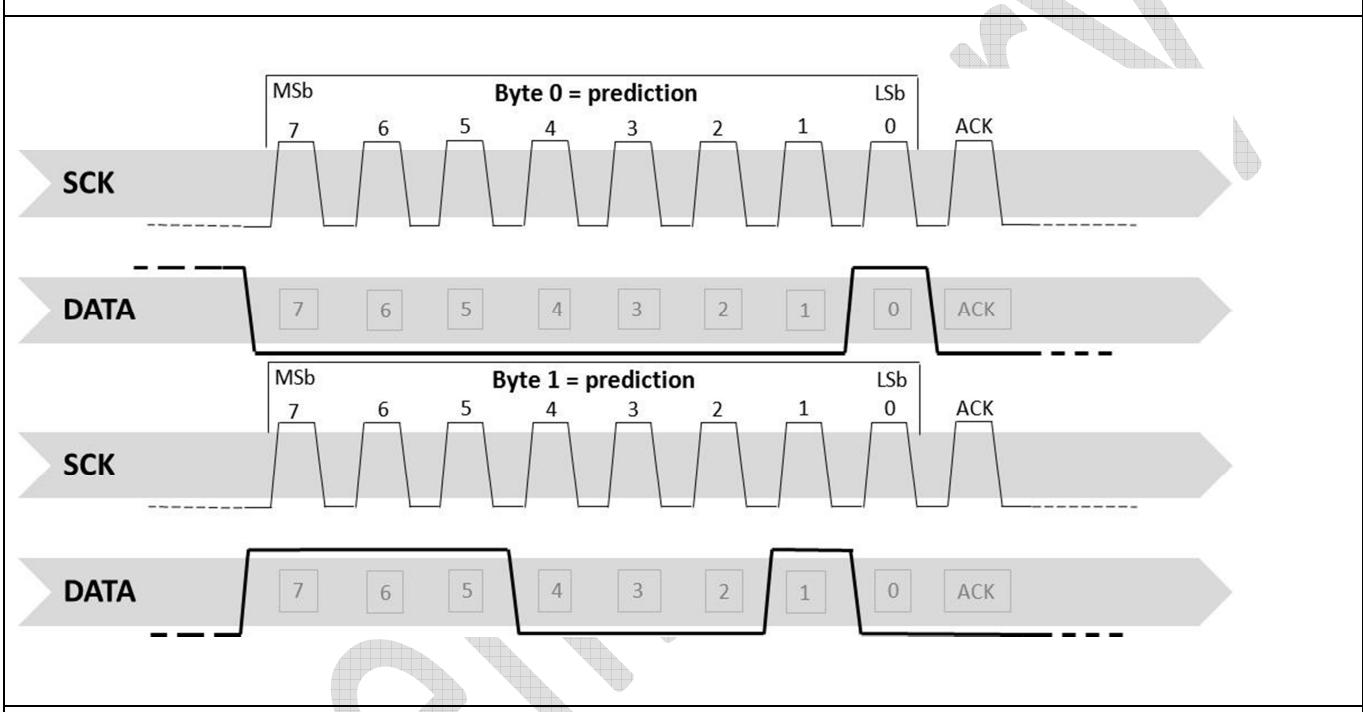
The standard I<sup>2</sup>C specification is used for the iAQ-core interface protocol. The I<sup>2</sup>C bus master should request 7 bytes. These seven bytes include information about the indoor air quality value, the iAQ-core status and the resistance of the sensor. If only the indoor air quality value and the status byte is required, the master should request three bytes from the iAQ-core. All bytes are reported back as shown in the following table. A graphical description for a standard I<sup>2</sup>C communication with the iAQ-core module is shown in figure 2 – figure 5.

Byte	Name	Data type	Typical/example value	Explanation / notes
0-1	pred	uint16	450	Prediction [ppm]
2	status	uint8	0	0x00: OK (data valid) 0x01: BUSY (re-read multi byte data!) 0x80: ERROR (if constant:replace sensor)
3-6	resistance	int32	256431	Sensor resistance [Ohm]

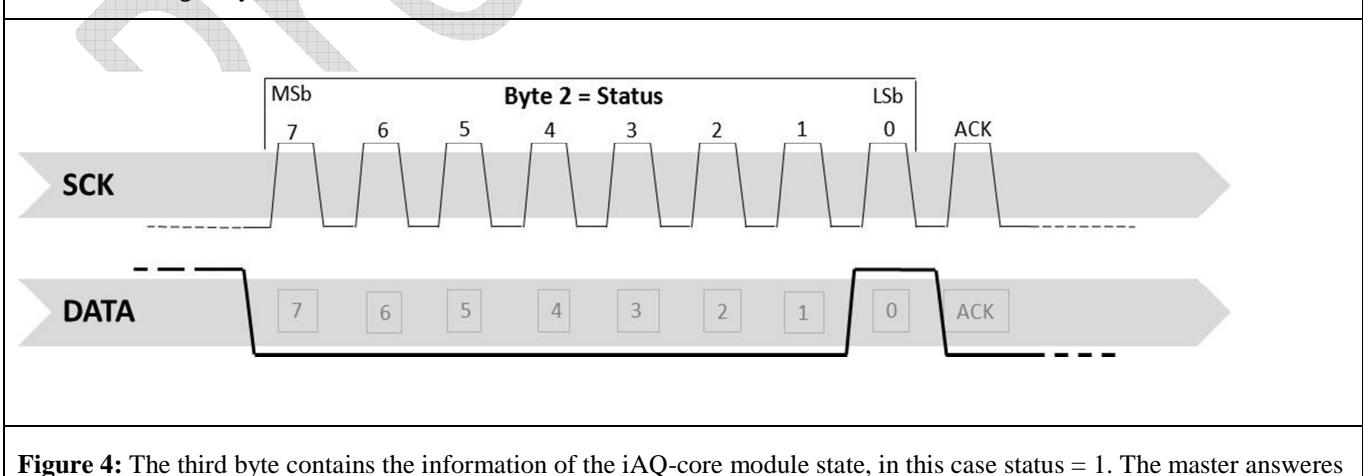
**Table 3:** Read data from the iAQ-core



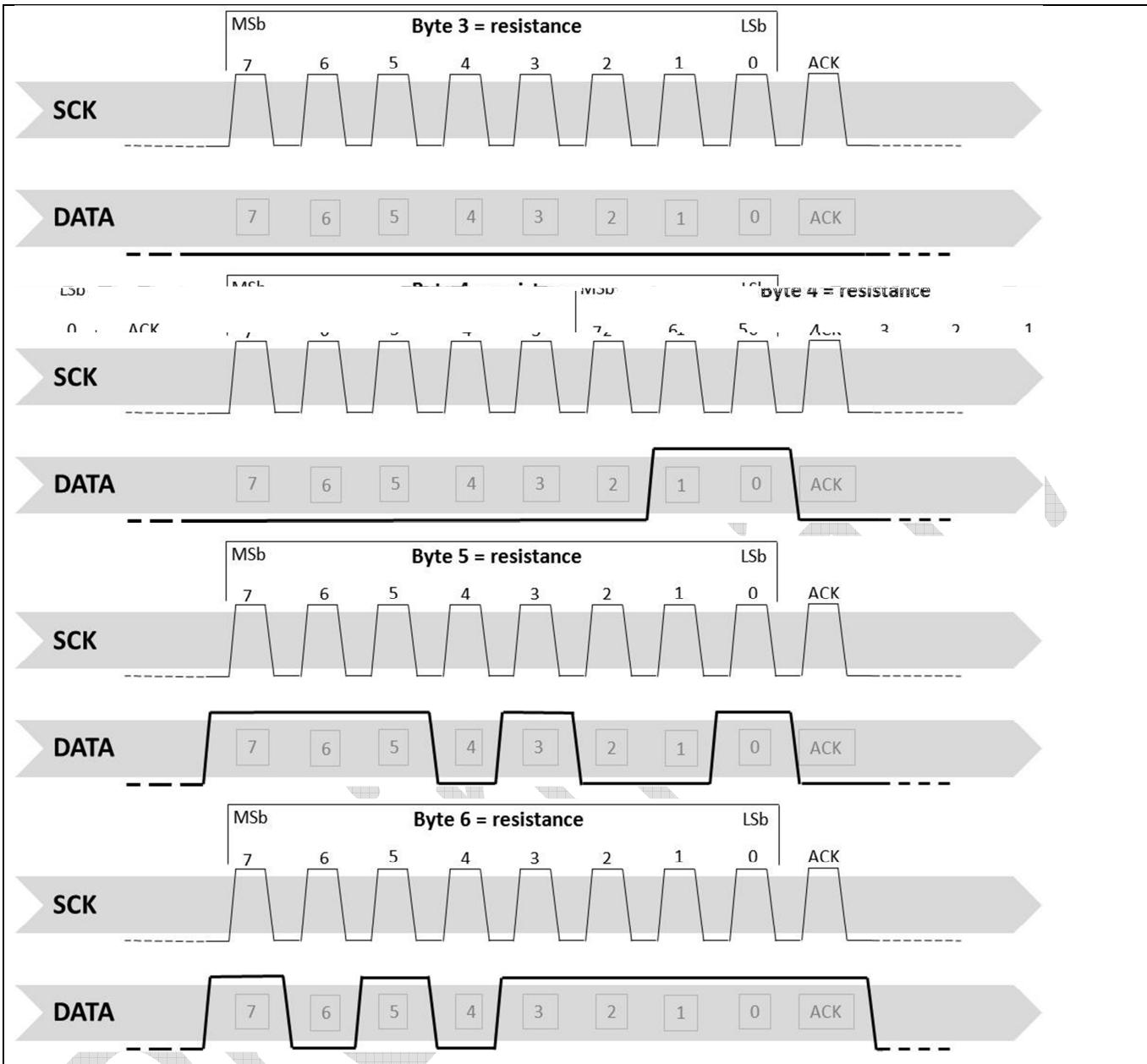
**Figure 2:** The first byte is send by the master, containing address (0x5A) and read/write bit. The slave sends an acknowledgement (ACK) by pulling the data line to low.



**Figure 3:** The slave will answer by sending bytes with MSB first. Byte0 and byte1 contain the prediction value. All bytes are Acknowledged by the master.



**Figure 4:** The third byte contains the information of the iAQ-core module state, in this case status = 1. The master answers with an Acknowledge.



**Figure 5:** The last four bytes contain the resistance value. For the calculation of the resistance only byte4, byte5 and byte 6 are relevant, because byte3 is zero. After the last requested byte, the master sends a Not Acknowledge.

#### 4.2.1 Prediction

Byte0	Byte1	Byte2	Byte3	Byte4	Byte5	Byte6
-------	-------	-------	-------	-------	-------	-------

The first two bytes contain the prediction value, which gives the information about the indoor air quality. The value is a CO<sub>2</sub> equivalent and the calculation is shown in the following example.

**Equation 1 :**

$$\text{Prediction} = \text{byte0} * 2^8 + \text{byte1}$$

#### 4.2.2 Status Flag

Byte0	Byte1	Byte2	Byte3	Byte4	Byte5	Byte6
-------	-------	-------	-------	-------	-------	-------

The third byte indicates status of the module.

- 0x00: OK
- 0x01: BUSY
- 0x80: ERROR

If status is OK the data is valid. If the status is BUSY, the data integrity is not guaranteed for variables of size > 8 bits, because the module may be updating a part of the variable.

If the status is ERROR constantly (or very frequently) this indicates that the module is reading non-realistic values, and the sensor element is probably defective.

#### 4.2.3 Resistance

Byte0	Byte1	Byte2	Byte3	Byte4	Byte5	Byte6
-------	-------	-------	-------	-------	-------	-------

The next four bytes contain the sensor resistance in Ohm. Byte3 is always 0.

**Equation 2:**

$$\text{Resistance} = \text{byte4} * 2^{16} + \text{byte5} * 2^8 + \text{byte6}$$

## 5 Application Information

### 5.1 Handling Instructions

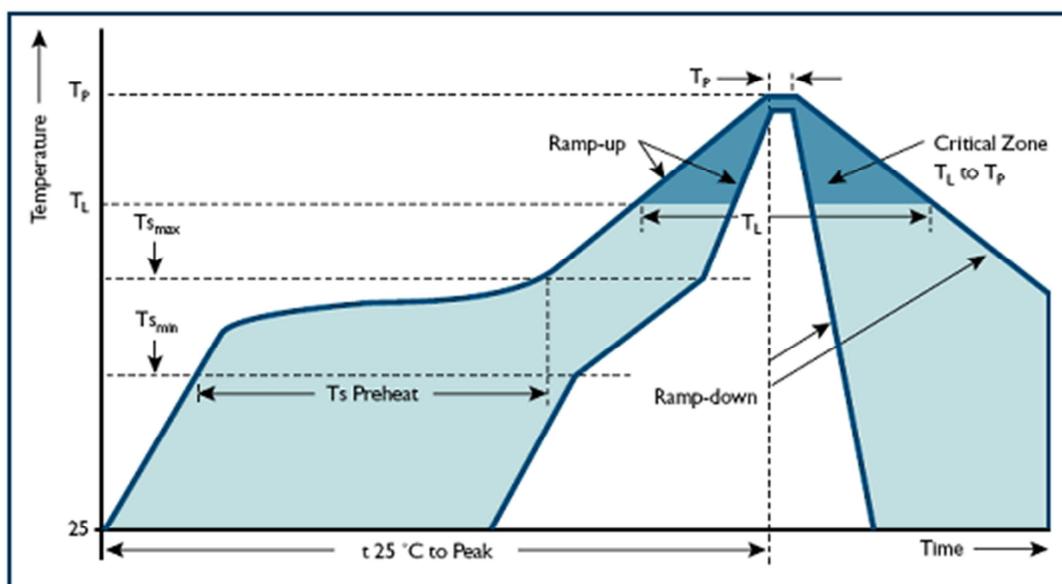
The iAQ-core module should be handled carefully, shear stress should be avoided. The sensor is protected by a membrane. This membrane should not be removed or touched.

### 5.2 Soldering Instructions

For soldering the iAQ-core, standard reflow soldering ovens could be used. The reflow ovens shall be purged with clean air. Other gases must be avoided. For the lead free reflow process a standard process IPC/JEDEC J-STD-020 with peak temperature up to 250°C is suggested. See figure 6 for more detailed description.

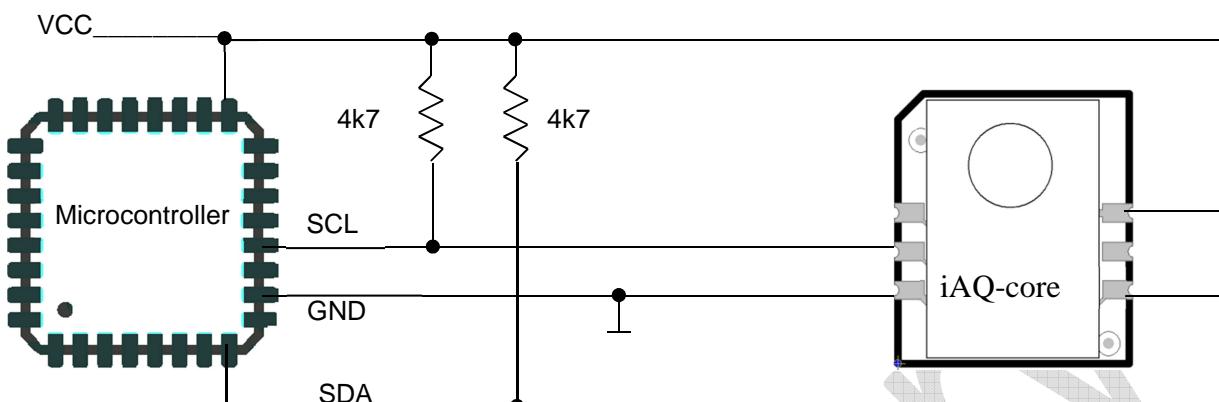
**Please note:** The device shall be kept clear of liquids; therefore a PCB washing process must be avoided in any case.

For manual soldering contact time must be limited to 5seconds at a maximum temperature of 350°C.



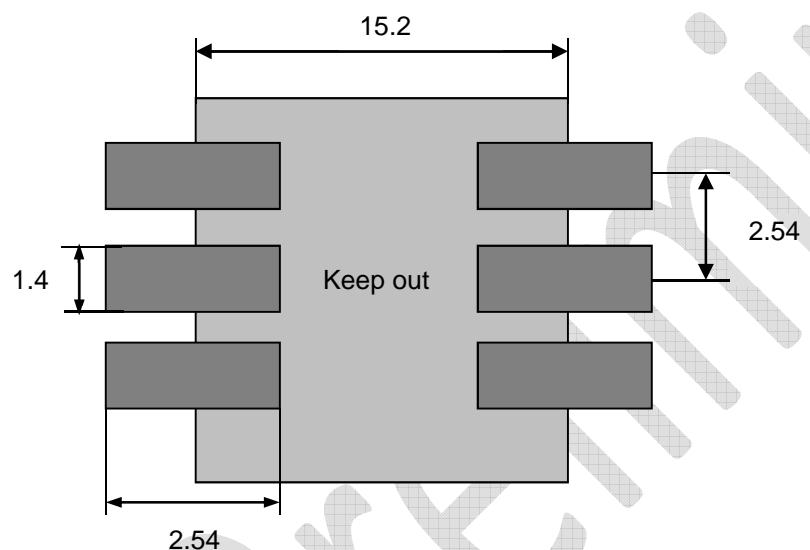
**Figure 6:**  $T_s \text{ min} = 150^{\circ}\text{C}$ ;  $T_s \text{ max} = 200^{\circ}\text{C}$ ;  $T_s \text{ Preheat} = 60\text{-}120\text{sec}$ ;  $T_L < 220^{\circ}\text{C}$  for  $< 150\text{sec}$ ;  $T_p \leq 250^{\circ}\text{C}$  for  $< 30\text{sec}$ ; Ramp-up/down speed shall be  $< 5^{\circ}\text{C/sec}$

### 5.3 Typical Application



**Figure 7:** Simple microcontroller application

### 5.4 Recommended footprint



**Figure 8:** Recommended footprint (standard)

### 5.5 Ordering information

Order code	Comment
60-0300	iAQ-core

Preliminary

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